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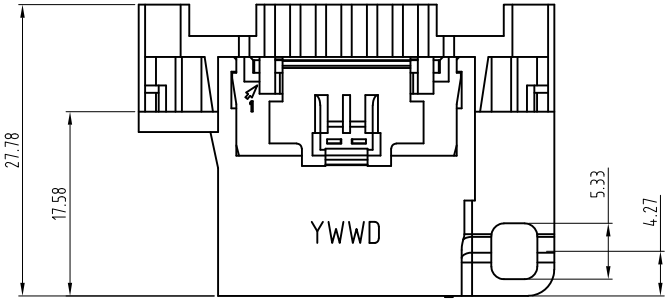
The marking on this product doesn't contain environmental hazardous materials per Material Specification SS-00259 for Sony GP compliant or per directive 2011/65/EU for RoHS compliant or per IEC 61249-2-21 for Halogen-Free compliant.

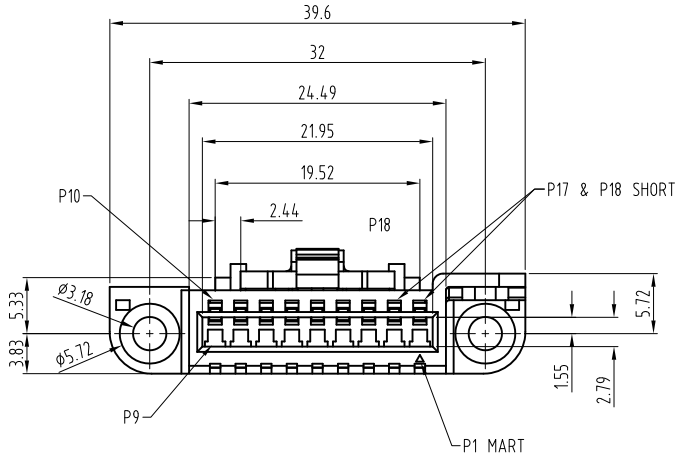
REVISIONS				
SYM	ECN No.	DESCRIPTION	DATE	BY
AX1	NE-XXXXX	UNRELEASED REVISION	2019.12.05	Joseph Jiang

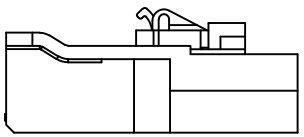


PARTS No.: GFM F 04 H X 1 X 0000HR

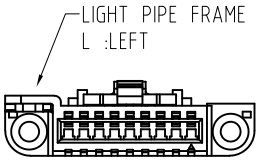
PCB THICKNESS
0: 1.6~2.4mm

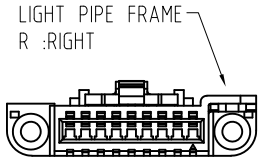
LIGHT PIPE FRAME LOCATION
R : RIGHT
L : LEFT





PART No.	PCB THICKNESS	GOLD PLATING	LIGHT PIPE FRAME	RECOMMEND IC CHIP TYPE
GFMF04H01R0000HR	1.6~2.4	G/F	RIGHT	STMicroelectronics SO8 SERIES





LIGHT PIPE FRAME LOCATION

NOTE:
1. MATERIAL:
 MAIN HOUSING: HIGH TEMPERATURE THERMAL PLASTIC, UL94V-0, COLOR: BLACK..
 CHIP TOP COVER: HIGH TEMPERATURE THERMAL PLASTIC, UL94V-0, COLOR: BLACK..
 CHIP HOUSING: HIGH TEMPERATURE THERMAL PLASTIC, UL94V-0, COLOR: BLACK..
 CONTACT: COPPER ALLOY..
2. FINISH:
 CONTACT: SELECTIVE GOLD PLATING ON THE CONTACT AREA,
 100μ" MIN. MATTE-TIN PLATING ON THE AREA.
 50μ" MIN. NICKEL UNDERPLATING OVERALL.
3.THIS PRODUCT DOESN'T CONTAIN ENVIRONMENTAL HAZARDOUS PER DIRECTIVE 2011/65/EU FOR ROHS COMPLIANT.

TOLERANCE	APPROVALS	DATE
X.	DRAWN	
X.X ±0.30	DESIGNED Joseph Jiang	2019.12.05
X.XX ±0.20	CHECKED Chenny Yeh	2019.12.05
X.XXX ±0.10	APPROVED Hank Hsu	2019.12.05
ANGULAR ±2°	DWG TYPE CUST DWG	PROJECT CODE T602
UNLESS OTHERWISE SPECIFIED		

TITLE: EDGE CARD CONNECTOR FOR SMART FAN MODULE 18 PIN

UNIT mm | SIZE A3 | SCALE NA | SHEET 1 OF 1

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PART No. GFMF04HX1X0000HR

DWG No. GFMF04HX1X0000HR | REV. AX1